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**on behalf of Glasgow group**  
**UK-V at RAL, 08 Sept 2004**

## **GLASGOW STATUS REPORT**

### **-Production queues:**

- received - 69 outer modules**
- bonded - 55 (30 recently in a queue)**
- completed - 26**
- testing - 22: 10-IV&Conf, 4-TC,  
5-IV&Char, 3-LTT**
- on hold - 7: ABCD & VDC/DORIC  
replacement, bond.defects**
- ready to go - 12 modules**

**-Current problems:**

- H & K: wire clamps**
- second technician is training**
- 10 bonded modules still have no db entry**
- growing number of redundancy failure → kaptons and patch card connectors**

**-Coming soon:**

- increase rate to 10 modules per week**
- complete testing box-6 (daq-2 is ready) to increase testing capacity to 10 modules (need more LV3's)**
- re-work**